

# 10 W SiC RF Power MESFET

# PRELIMINARY

## Features

- 12 dB Small Signal Gain
- 10 W Minimum  $P_{1dB}$
- 48 V Operation
- High Breakdown Voltage
- High Temperature Operation
- Up to 3 GHz Operation
- High Efficiency

## Applications

- Class A, AB Amplifiers
- TDMA, EDGE, CDMA, and W-CDMA
- Broadband Amplifiers
- CATV Amplifiers
- MMDS

## Description

Cree's CRF-22010 is a silicon carbide (SiC) RF power Metal-Semiconductor Field-Effect Transistor (MESFET). SiC has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity, and higher thermal conductivity. SiC MESFETs offer greater power density and increased reliability compared to Si and GaAs transistors.



## Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DSS}$	120	VDC
Gate-Source Voltage	$V_{GS}$	-25, +3	VDC
Total Device Dissipation	$P_D$	62.5	W
Storage Temperature	$T_{STG}$	-40, 150	°C
Operating Junction Temperature	$T_J$	250	°C
Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.6	°C/W
Soldering Temperature	$T_S$	250	°C

**Electrical Characteristics (T<sub>C</sub> = 25°C)**

Characteristic	Symbol	Min	Typ	Max	Units	Conditions
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**DC CHARACTERISTICS**

Gate Threshold Voltage	V <sub>GS(th)</sub>	-12	-10	-	VDC	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.5 mA
Gate Quiescent Voltage	V <sub>GS(Q)</sub>	-	-6	-	VDC	V <sub>DS</sub> = 48 V, I <sub>D</sub> = 500 mA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	1.1	1.5	1.8	A	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	100	110	120	VDC	V <sub>GS</sub> = -26 V, I <sub>D</sub> = 3 mA
Forward Transconductance	g <sub>m</sub>	-	150	-	mS	V <sub>DS</sub> = 48 V, I <sub>D</sub> = 500 mA
Case Operating Temperature	T <sub>C</sub>	-30	-	120	°C	
Screw Torque (101 Style Package)	T	0.33	-	0.37	ft·lb	

**RF CHARACTERISTICS**

Gain	G <sub>SS</sub>	10	12	-	dB	V <sub>DD</sub> = 48 V, I <sub>DQ</sub> = 500 mA, f = 2000 MHz
Power Output at 1 dB Compression	P <sub>1dB</sub>	10	12	-	W	V <sub>DD</sub> = 48 V, I <sub>DQ</sub> = 500 mA, f = 2000 MHz
Drain Efficiency <sup>1, 2</sup>	η	40	45	-	%	V <sub>DD</sub> = 48 V, I <sub>DQ</sub> = 500 mA, f = 2000 MHz, P <sub>OUT</sub> = P <sub>1dB</sub>
Intermodulation Distortion	IMD <sub>3</sub>	-	-30	-	dBc	V <sub>DD</sub> = 48 V, I <sub>DQ</sub> = 500 mA, f <sub>1</sub> = 2000.0 MHz, f <sub>2</sub> = 2000.1 MHz, P <sub>OUT</sub> = 10 W PEP

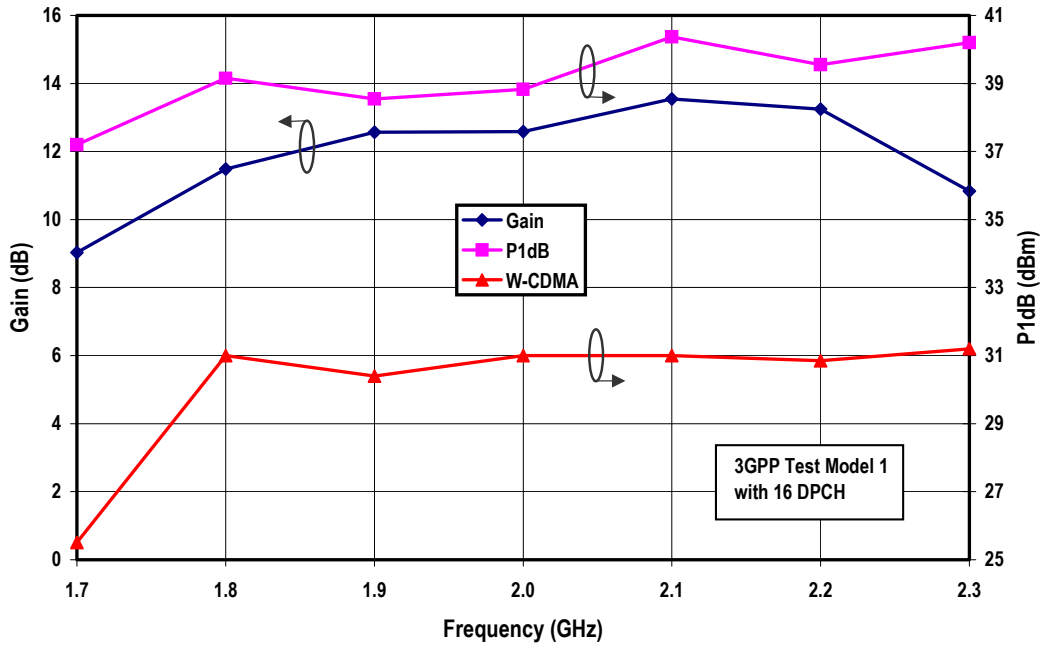
Notes:

<sup>1</sup> Drain Efficiency = P<sub>OUT</sub>/P<sub>DC</sub>

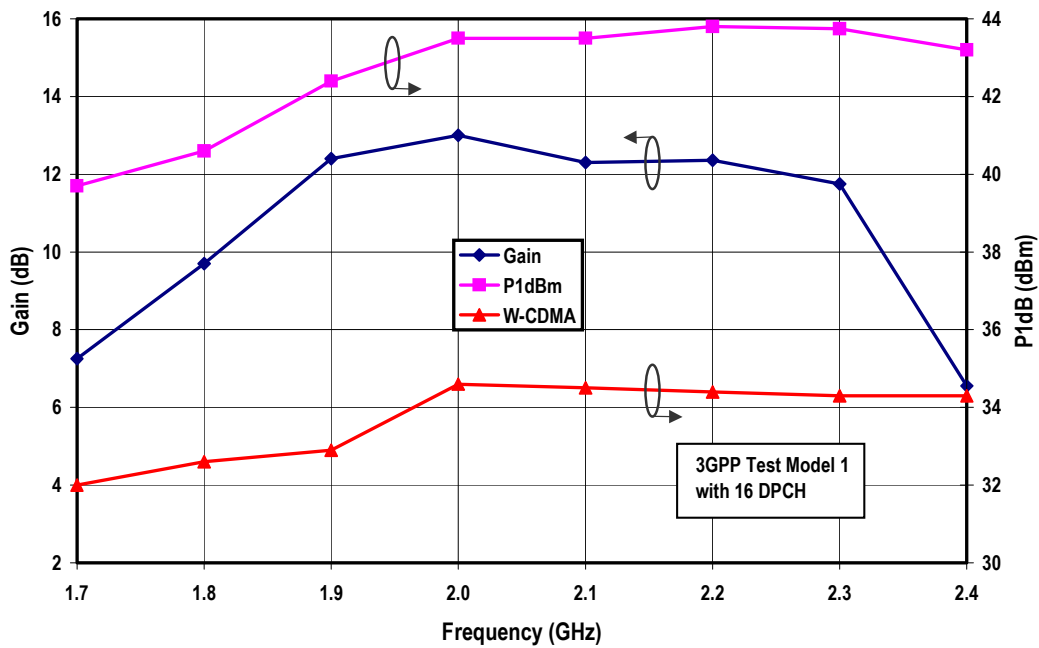
<sup>2</sup> Power Added Efficiency (PAE) = (P<sub>OUT</sub> - P<sub>IN</sub>)/P<sub>DC</sub>

Typical Broadband Performance ( $T_C = 25^\circ\text{C}$ ,  $V_{DS} = 48\text{ V}$ ,  $I_{DQ} = 500\text{ mA}$ )

CR22010 Single-Ended Broadband Amp; Untuned Prototype

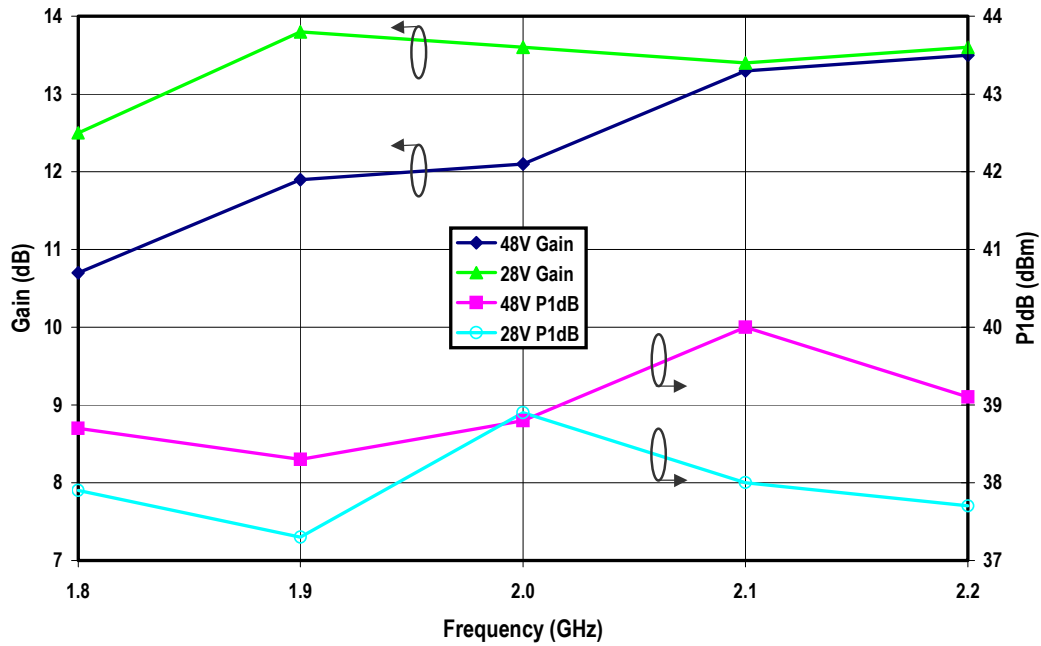


CR22010 Balanced Broadband Amp  
 $V_{ds}=48\text{V}$ ,  $I_{dq}=500\text{mA/Device}$ ; Untuned Prototype

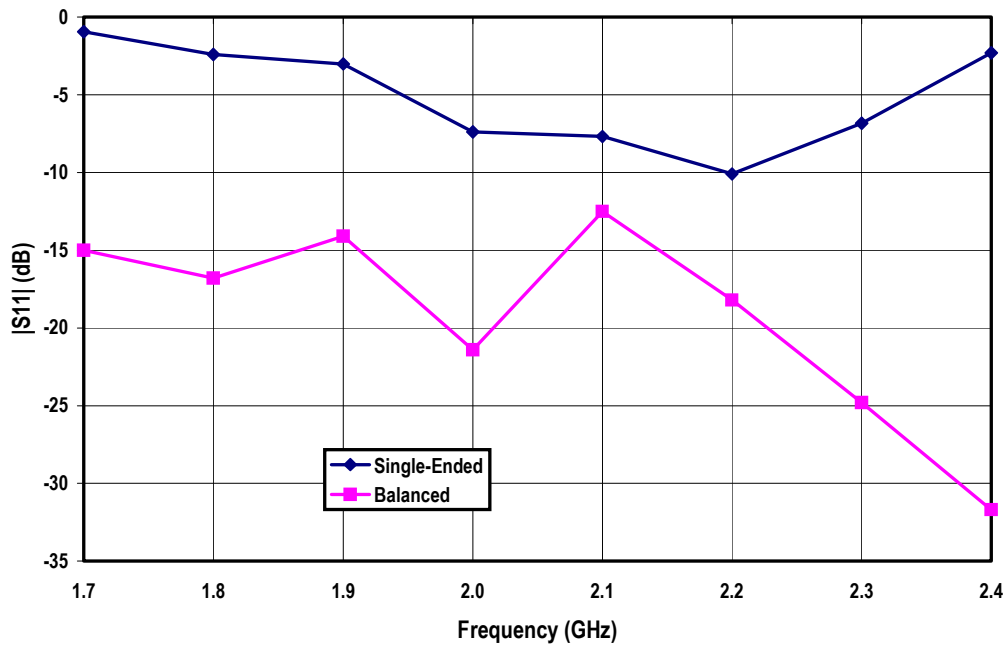


**Typical Broadband Performance ( $T_C = 25^\circ\text{C}$ ,  $V_{DS} = 48\text{ V}$ ,  $I_{DQ} = 500\text{ mA}$ )**

**CR22010 Single-Ended Broadband Amp**  
 $V_{ds}=48\text{V}$  and  $28\text{V}$ ,  $I_{dq}=500\text{mA}$ ; Untuned Prototype

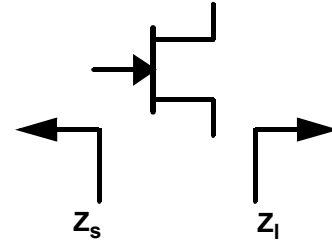
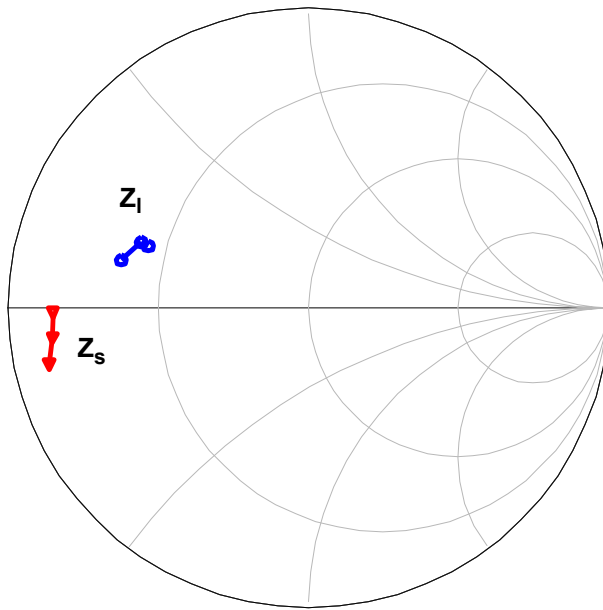


**CR22010 Single-Ended and Balanced Amp |S11|; Untuned Prototype**



**Typical Scattering Parameters (Small Signal Class A,  $V_{DS}=48$  V,  $I_{DQ} = 500$  mA, ang in deg)**

freq	S(1,1)	S(1,2)	S(2,1)	S(2,2)
100.0MHz	0.992 / -24.815	0.022 / 75.220	8.534 / 164.613	0.222 / -38.721
200.0MHz	0.972 / -47.553	0.041 / 61.737	7.928 / 150.522	0.260 / -68.263
300.0MHz	0.948 / -67.048	0.056 / 50.220	7.153 / 138.396	0.299 / -88.841
400.0MHz	0.925 / -83.140	0.066 / 40.689	6.372 / 128.258	0.332 / -103.288
500.0MHz	0.907 / -96.226	0.074 / 32.845	5.664 / 119.807	0.357 / -113.709
600.0MHz	0.893 / -106.865	0.079 / 26.326	5.053 / 112.682	0.376 / -121.434
700.0MHz	0.882 / -115.585	0.082 / 20.818	4.535 / 106.568	0.391 / -127.302
800.0MHz	0.874 / -122.815	0.085 / 16.078	4.099 / 101.223	0.403 / -131.859
900.0MHz	0.868 / -128.889	0.087 / 11.925	3.730 / 96.466	0.413 / -135.472
1.000GHz	0.864 / -134.057	0.088 / 8.226	3.416 / 92.163	0.423 / -138.389
1.100GHz	0.860 / -138.512	0.089 / 4.884	3.148 / 88.219	0.431 / -140.787
1.200GHz	0.858 / -142.398	0.090 / 1.826	2.916 / 84.559	0.439 / -142.792
1.300GHz	0.856 / -145.826	0.091 / -1.003	2.714 / 81.130	0.447 / -144.496
1.400GHz	0.854 / -148.880	0.091 / -3.644	2.538 / 77.890	0.454 / -145.970
1.500GHz	0.853 / -151.628	0.091 / -6.129	2.383 / 74.807	0.461 / -147.264
1.600GHz	0.852 / -154.123	0.092 / -8.483	2.245 / 71.857	0.468 / -148.418
1.700GHz	0.852 / -156.406	0.092 / -10.726	2.122 / 69.019	0.475 / -149.464
1.800GHz	0.852 / -158.512	0.092 / -12.874	2.011 / 66.278	0.482 / -150.425
1.900GHz	0.852 / -160.468	0.092 / -14.939	1.912 / 63.621	0.489 / -151.320
2.000GHz	0.852 / -162.297	0.092 / -16.932	1.822 / 61.038	0.495 / -152.164
2.100GHz	0.852 / -164.018	0.092 / -18.863	1.741 / 58.520	0.502 / -152.968
2.200GHz	0.852 / -165.647	0.092 / -20.737	1.667 / 56.060	0.509 / -153.743
2.300GHz	0.853 / -167.196	0.092 / -22.562	1.599 / 53.651	0.515 / -154.496
2.400GHz	0.853 / -168.678	0.092 / -24.342	1.537 / 51.289	0.521 / -155.233
2.500GHz	0.853 / -170.102	0.092 / -26.083	1.480 / 48.968	0.528 / -155.958
2.600GHz	0.854 / -171.477	0.092 / -27.787	1.427 / 46.686	0.534 / -156.675
2.700GHz	0.854 / -172.809	0.092 / -29.460	1.379 / 44.439	0.540 / -157.389
2.800GHz	0.855 / -174.106	0.092 / -31.103	1.334 / 42.223	0.546 / -158.100
2.900GHz	0.855 / -175.372	0.091 / -32.720	1.293 / 40.035	0.552 / -158.811
3.000GHz	0.856 / -176.613	0.091 / -34.313	1.255 / 37.874	0.557 / -159.525
3.100GHz	0.856 / -177.833	0.091 / -35.884	1.219 / 35.738	0.563 / -160.241
3.200GHz	0.857 / -179.037	0.091 / -37.437	1.186 / 33.622	0.568 / -160.962
3.300GHz	0.857 / 179.772	0.091 / -38.972	1.155 / 31.527	0.573 / -161.688
3.400GHz	0.857 / 178.591	0.091 / -40.492	1.127 / 29.450	0.578 / -162.421
3.500GHz	0.858 / 177.416	0.091 / -41.999	1.100 / 27.389	0.583 / -163.160
3.600GHz	0.858 / 176.245	0.091 / -43.494	1.075 / 25.342	0.588 / -163.906
3.700GHz	0.858 / 175.074	0.091 / -44.979	1.052 / 23.309	0.592 / -164.661
3.800GHz	0.859 / 173.902	0.091 / -46.456	1.031 / 21.286	0.597 / -165.424
3.900GHz	0.859 / 172.726	0.092 / -47.927	1.011 / 19.273	0.601 / -166.196
4.000GHz	0.859 / 171.543	0.092 / -49.393	0.993 / 17.267	0.605 / -166.977



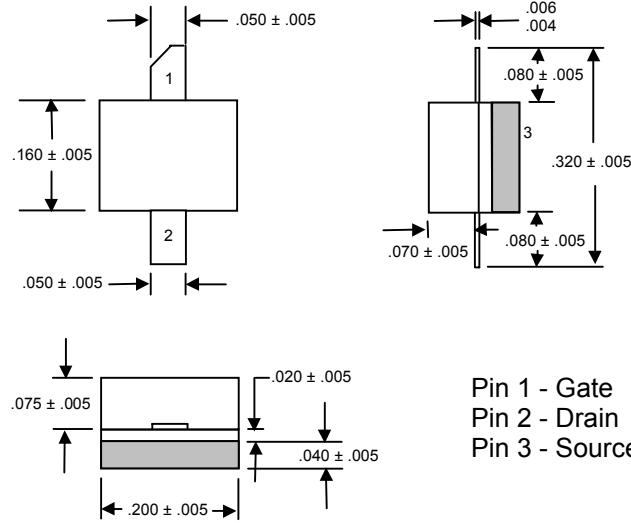
$Z_s$  - Input match from gate  
 $Z_i$  - Output match from drain

**10 W Class A Impedance Data,  $V_{DS} = 48\text{ V}$ ,  $I_{DQ} = 500\text{ mA}$ , 101 Style Package**

Frequency MHz	$Z_s$ (ohms)		$Z_i$ (ohms)	
	R	jX	R	jX
1805	4.0	-0.5	14	8.7
1990	3.8	-3.0	13	9.0
2170	3.1	-5.4	11	6.0

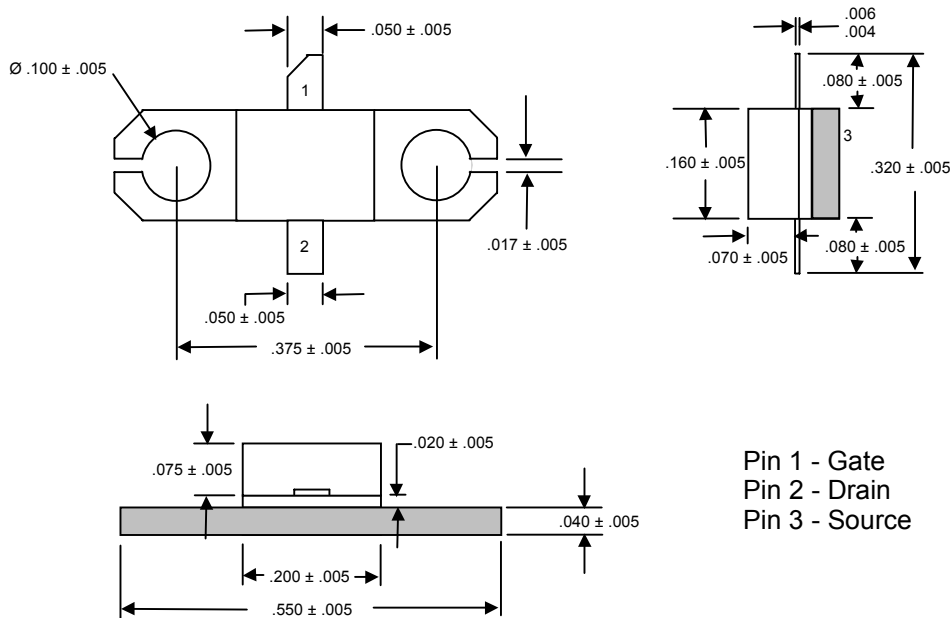
**PACKAGE DIMENSIONS (UNITS IN INCHES)**

**STYLE 001**



Pin 1 - Gate  
Pin 2 - Drain  
Pin 3 - Source

**STYLE 101**



Pin 1 - Gate  
Pin 2 - Drain  
Pin 3 - Source

All products conform to the listed mechanical specifications within the tolerances shown.

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